

Ku Band Uplink MMIC PA's on 10 GHz.

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INTRODUCTION.

For many years I have been modifying all manner of Ku Uplink hardware down to 10 GHz. The reason - the cost of 10 GHz GaAs Power FET's is usually prohibitive.

However, the problem with trying to modify the vast majority of Ku Band PA's down to 10 GHz lies with the GaAs FET Output Devices that Satellite Companies often use.

Ku Uplink hardware operates in the range 14.00 through to 14.50 GHz. The Manufacturers of Ku ODU usually design their Ku Band PA's with "power" GaAs FET's that have a nominal specified Operating Frequency Range of circa 13.5 GHz to 14.5 GHz.

The majority of these GaAs FET devices are IMFET's (Internally Matched FET's). These IMFET devices have been deliberately fabricated to (only) operate over a "limited" Frequency range.

This has been achieved by the inclusion of Inductive and Capacitive elements within the FET structure. Semiconductor manufacturers deliberately include these "Reactive" elements to provide "stable" Gain across the nominal Pass Band and NOT beyond.

The result is that these additional Reactive components have a minimal effect within the Pass Band of the device but these same components cause the device Gain to degrade outside of this nominal Pass Band.

Our 10 GHz Amateur Band is clearly a long way outside (almost 3 GHz below) the Design Specifications of these Ku Band IMFET devices. However, myself and indeed many other Amateurs have found that many of these Ku Band IMFET's will deliver useful performance (Gain) on 10 GHz.

The same scenario also applies to C Band IMFET's covering 5.9 -6.4 GHz and their reuse on 5.76 GHz.

However, there is one caveat on this Modification process!

The "retuning" process around these IMFET's is often VERY tedious... requiring many hours of fiddly "Snow Flaking".

On a more positive note – I recently, I acquired a quantity of scrap 4 Watt Ku Band ODU's.

Once again I had to consider the value of the Ku Band Output devices and their potential for 10 GHz Operations.

And so there was that usual lingering concern about the significant effort required for "retuning" these Ku Band PA's versus the desired performance on 10 GHz.

To my great surprise, when I dismantled an ODU, I found the ODU Manufacturer had used a pair of high Gain, Phased Ku MMIC's from Eudyna. The Part Numbers used were FMM5081 and FMM5059. Oddly, the Eudyna Spec's for both these MMIC's look to be identical. They have a specified Frequency range of 13.75 GHz to 14.5 GHz, a Gain of circa 30 dB and they deliver more than 2 Watts.

With such a High Gain compared to that of a high power GaAs FET (6-7 dB), if this Ku Band MMIC could be made to work on 10 GHz it would be a good cheap alternative to that ever popular Eudyna X Band MMIC - FMM5061.

Amateur Radio Operators love the FMM5061 MMIC because of its simplicity. It delivers MORE than 2 Watts

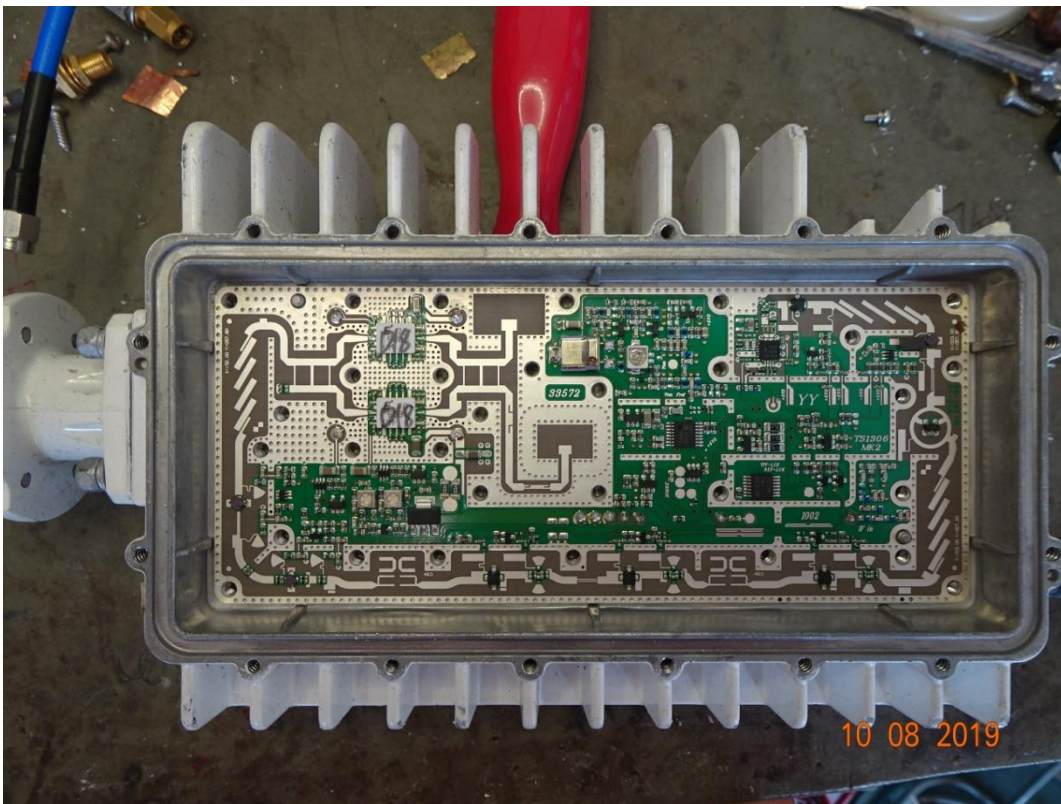
on 10368 MHz with circa 10 Milliwatts of RF drive. Although this MMIC is a very simple solution - delivering high Gain and good RF Power on 10 GHz, it has a couple of drawbacks.

The unit price is fairly costly at circa \$US100 from multiple ePray Dealers and then one still needs to find/fabricate a purpose built PCB to mount it etc.

NB : Down East Microwave (DEM) used to offer this FMM5061 MMIC as a complete 3 Watt Amplifier Kit for more than \$US300 but it seems to have gone from their Sales Inventory.

TECHNICAL DISCUSSION.

With these thoughts in mind, I immediately set about modifying these Ku Band MMIC PA's down to 10 GHz. Below is a Photo of the Ku Band ODU main board.



The 2 off Phased Eudyna MMIC's are top left.

There are 4 off PCB Pads for DC Supply Rails. The two on the left are the -Vgg Bias Rails whilst the 2 on the right are the +VDD Rails.

Note also the 2 off Wilkinson Splitters for the I/O Combining. The Input Splitter has a discrete SMD 50 Ohm Balance Load (lower left) while the Output Splitter has a coaxial "Pad" above an integrated waveguide chamber as it's Balance Load (upper right).

The 14 GHz RF output is coupled via it's longer Stripline (lower right) to a coaxial "Pad" above another waveguide

chamber which ultimately couples towards the Feed Horn (Left).

And finally there are 2 Tuning "stubs" on the Output Striplines immediately to the left of the Output Splitter.

All of these frequency dependent "elements" have been designed for Ku Band functionality.

So... if we wish to use this MMIC in a potential 10 GHz application these "elements" must be removed (Scalpel) leaving only the I/O Striplines that feed the individual MMIC's.

MODIFICATION PROCESS.

This description has been written on the basis that any Operator can emulate the actions I have implemented on similar alternate Ku Band ODU's.

Most Ku Band ODU's operate from a single circa +20 Volt Supply. Since both MMIC's were already mounted on a PCB with Heatsinking and complete with their DC supply rails, I decided to attempt a Modification within the original case/hardware.

With the knowledge that all GaAs FET's need some form of DC isolation in their RF ports, I initially fitted SMD DC Isolation capacitors (3.9pf) in each Stripline. However, this was later found to be unnecessary because the Eudyna Datasheet shows "integrated" DC isolation was already included.

So... the next task was to fit I/O Coax tails to couple the RF In/Out of each MMIC. To achieve the best possible RF coupling, each I/O Coax needs a good Ground Plane. To achieve this I decided to solder some copper "shim" material linking as much of the existing Ground Planes as possible. While there are slight layout differences between each MMIC PCB (refer Photo below), the RF Earthing issues will be fairly obvious to see/work out.

For the Coax connections, I initially tried .141 Hardline but the large physical step from the PCB Track to the centre conductor caused RF Coupling issues. The smaller .085 Hardline is a much better choice but I finally settled on using some flexible Teflon tails that I had scavenged from other equipment. I then soldered in these short Coax Tails to the I/O Strip Lines and the newly created Ground Planes.

The Power Meter (HP435A) was connected via a 30 dB Attenuator. After Powering Up the ODU, I checked the +VDD and -Vgg Supply rails and then Set the RF Drive to +13 dBm.

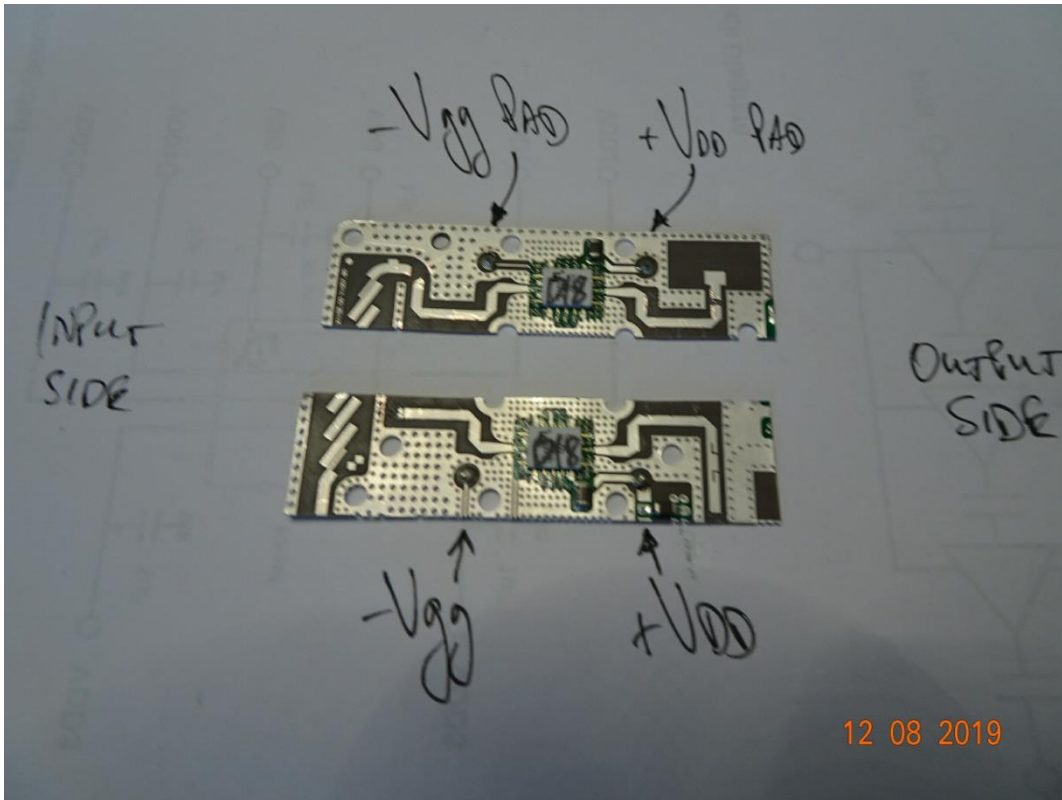
I immediately saw a few 100 Milliwatts of RF Output. This was a very positive result for an as yet "untuned" PA.

Over the next few hours I ultimately found the simplest "Snowflaking" solution that delivered the highest Gain with maximum Output.

The final result was more than +30 dBm Output (1.2 Watts typical) with +13 dBm Drive. A Drive level of +10 dBm delivers circa 750 Milliwatts.

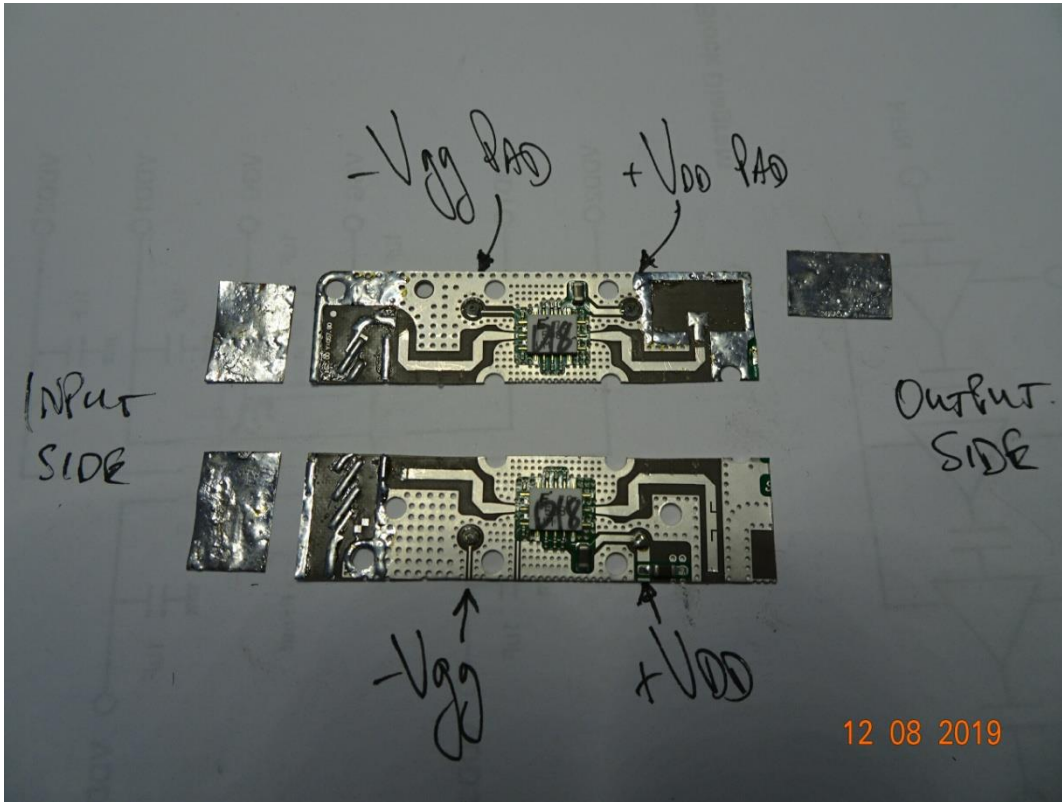
With such a pleasing result I then decided to remove (cut) these dual MMIC PA's from the Main PCB and to split them into separate amplifiers. These PCB's are VERY small !! They are only 70mm X 18mm. In USA parlance... that's less than 3 Inches long and only ¾ Inch wide.

Once again, all Frequency dependent "elements" were removed leaving just the I/O Striplines feeding the MMIC's.



When I first mounted the top PCB to a Heatsink I discovered I had DC short circuit problems. It turned out that I had missed seeing that each PCB has Through Hole Plated DC Pads for both +VDD and the -Vgg Supply Rails. My alternate Heatsink effectively shorted these exposed Pads to Earth. To overcome this, I had to either drill a small countersunk hole in the Heatsink directly under this Pad or simply suck the solder out of this Pad and use a small Drill to eliminate the contact point of Through Hole "Pad" on the underside of the PCB before Mounting on the Heatsink. For the lower PCB, I also had to solder a very fine wire from the Vgg Bias connection to it's Bias Pad marked -Vgg.

The next part of the process was the creation of the Ground Planes for each of the I/O Coax tails.

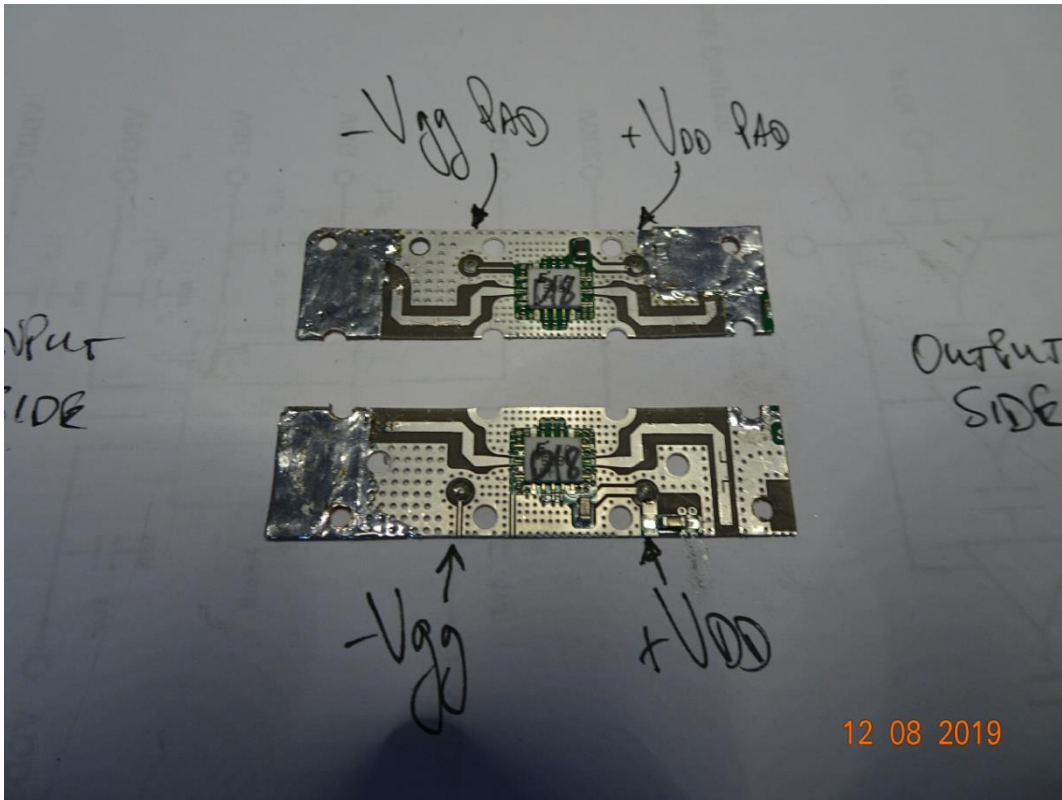


To maximise adhesion of the "tinned" copper shim material, on the Input I chose to leave all the RF Tracks intact.

So... "tin" all surrounding copper tracks on the PCB and then lap the preformed shim over the entire surface and solder.

Note also the I/O Striplines have been trimmed ready for their RF connections.

Below is a Photo of the completed Ground Planes.

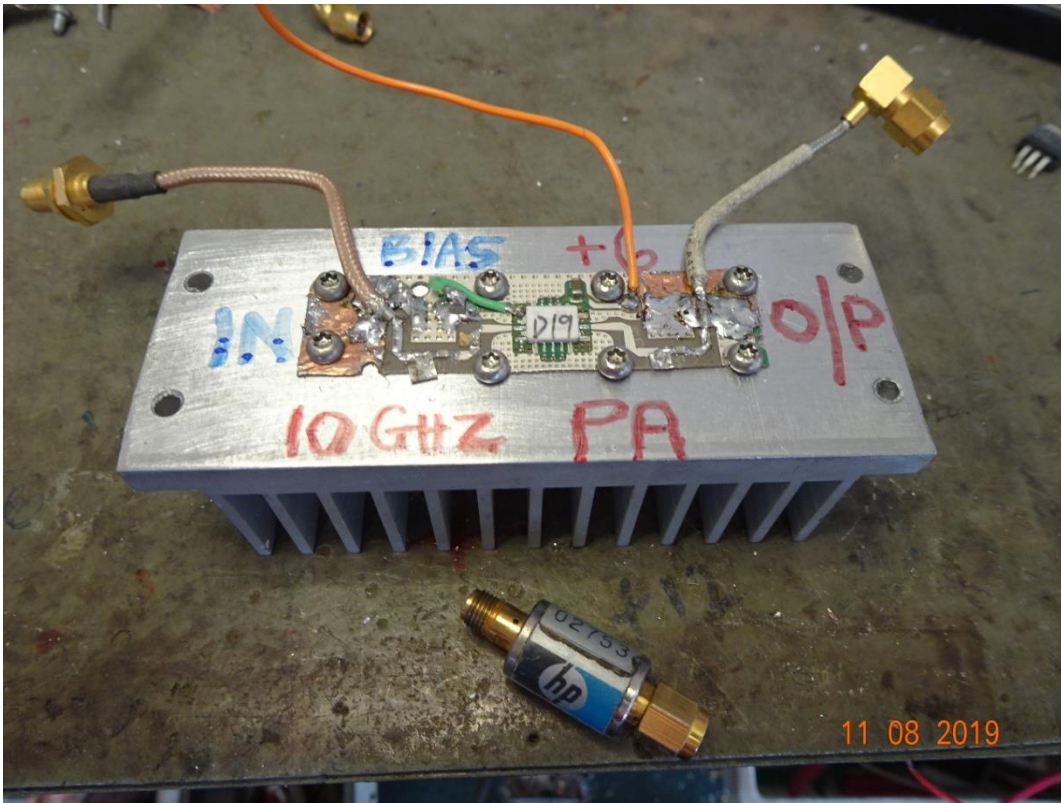


Readers will hopefully note that I have restored (created) the PCB Mounting holes. I suggest 8 holes are needed for best RF Grounding. I cannot emphasise enough how important it is to fit all 8 Screws (3mm ?) or Self Tappers to ensure best RF Grounding. Poor RF Grounding means reduced Output !!!

A mandatory smear of Heat Sink Compound under the MMIC is also necessary to achieve optimum heat transfer.

After carefully mounting the PCB on a suitable Heatsink, I then fitted the I/O Coax tails and repeated the "Snow Flake" (retune) task. For the most part, there are only 3 or 4 Snowflakes needed to optimise this PA.

The final result can be seen here in this Photo of a single Amplifier.



This Amplifier requires 2 Supply Rails... a Negative Bias Rail Vgg (Green wire) of circa -0.20 Volts and +VDD Rail in the range +5 to +6 Volts maximum.

The +VDD Rail is simply a short piece of hookup wire (Orange wire) on the O/P side of the MMIC.

A similar arrangement can be adopted for the Vgg Supply.

Note that for this PA the -Vgg Bias Rail (now) appears on an SMD capacitor that I soldered directly to the PCB.

To achieve the quite low -Vgg Voltage Rail of circa -0.20 Volts, I used a -5 Volt Supply developed from a 7660 Chip or similar. This -5 Volts is coupled to a 3.9K Resistor in series with a 1K Pot.

The centre of this Pot delivers a maximum of -1.0 Volts.

The reason for this Bias arrangement is because the Absolute Maximum Bias voltage for this MMIC is -3.0 Volts.

Before I connected the +6 Volt VDD Rail, I preset the -Vgg Rail to circa -1.0 Volts to "Set" the PA at Cut Off.

This ensures the MMIC will not destroy itself if the +6 Volt VDD Supply rail is NOT Current limited (i.e. 2 Amps max).

The recommended quiescent IDD for these MMIC's is 1200 mA.

To achieve this IDD, I carefully reduced the -Vgg voltage whilst monitoring the +6 Volt IDD current.

The final -Vgg Bias voltage was circa -0.20 Volts.

The application of RF Drive will push this IDD current up towards 1.5 Amps and more, hence the need for an adequate Heatsink or small Fan.

MMIC PA AVAILABILITY.

These modified MMIC PA's are a VERY simple way to get good RF Power on 10 GHz.

To inspire more interest in 10 GHz - I am offering unmodified PCB's (only) for FREE.

All I ask is for the Operator to cover the Postage costs.

Enthusiastic Operators with the desire to build their own gear will then need to create the Ground Planes, fit the I/O Coax tails, mount the PCB on a suitable Heatsink, tune the Striplines (Snow Flaking) and fabricate the +6 Volt VDD and -5 Volt Vgg Supply rails.

Aside from this Article - I can/will supply a brief Fact Sheet on how to Snowflake (location) these PCB's.

For those Op's who don't wish to Modify a PCB or perhaps do not have the Test Gear or are not confident with the Snow Flaking process, I have already modified more than a dozen of these PCB's (only).

Operators will then only need to carefully Mount the modified PCB on a suitable Heatsink etc.

These complete tested 1 Watt, 10 GHz PA's (PCB's only) sell for \$Au50 (\$US35) plus a bit for P&P.

I will guarantee every modified PA with a Replacement or Refund if a/any unit fails to meet expectations.

Please be aware that the addition of the Ground Planes and the I/O Coax tails has resulted in these modified PA's

not looking the tidiest Amplifiers around.

But... who cares !!!!

My attitude is this - so long as these PA's work as promised... then how they "look" is not a major issue.

Of greatest importance to me is/was my goal of re-purposing this scrapped RF hardware.

These cute little Amps are definitely a VERY simple and cheap solution for a high Gain 10 GHz Amplifier that delivers more than 1 Watt with a modest RF Drive level up to +13 dBm.

If these (10 GHz) MMIC PA's interest you.... drop me an Email to alandevlin@bigpond.com

Cheers,

Alan - VK3XPD